DLC70B (.110" x .110")

◆ Product Features

High Q, High Power, Low ESR/ESL, Low Noise, High Self-Resonance, Ultra- Stable Performance.

◆ Product Application

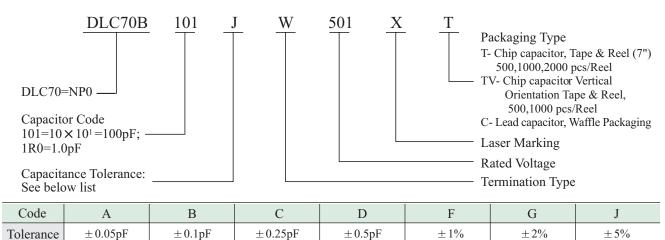
Typical Functional Applications: Bypass, Coupling, Tuning, Feedback, Impedance Matching and D.C. Blocking.

Typical Circuit Applications: UHF/Microwave RF Power Amplifiers, Mixers, Oscillators, Low Noise Amplifiers,
Filter Networks, Timing Circuits and Delay Lines

♦ DLC70B Capacitance Table

Cap.pF	Code	Tol.	Rated WVDC	Cap.pF	Code	Tol.	Rated WVDC	Cap.pF	Code	Tol.	Rated WVDC	Cap.pF	Code	Tol.	Rated WVDC
0.1	0R1			3.6	3R6			43	430			510	511		
0.2	0R2	A,		3.9	3R9			47	470			560	561		100V
0.3	0R3	В		4.3	4R3			51	510		500V	620	621		Code 101
0.4	0R4			4.7	4R7			56	560		Code 501	680	681	F,	or
0.5	0R5			5.1	5R1	Α,		62	620		or	750	751	G, J	200V
0.6	0R6			5.6	5R6	В,		68	680		1500V	820	821	,	Code
0.7	0R7			6.2	6R2	C,		75	750		Code	910	911		201
0.8	0R8			6.8	6R8	D		82	820		152	1000	102		
0.9	0R9		500V	7.5	7R5		500V	91	910			1100	112		200V
1.0	1R0		Code	8.2	8R2		Code	100	101			1200	122		Code
1.1	1R1		501	9.1	9R1		501	110	111	F,	300V	1500	152		201
1.2	1R2		or 1500V	10	100		or 1500V	120	121	G,	Code	1800	182		
1.3	1R3	A,	Code	11	110		Code	130	131	J	301	2200	222		
1.4	1R4	В,	152	12	120		152	150	151		or	2700	272		
1.5	1R5	C,		13	130			160	161		1000V	3000	302	G,	100V
1.6	1R6	D		15	150			180	181		Code 102	3300	332	J	Code
1.7	1R7			16	160			200	201		102	3900	392		101
1.8	1R8			18	180	F,		220	221			4700	472		
1.9	1R9			20	200	G,		240	241		200V	5100	512		
2.0	2R0			22	220	J		270	271		Code	5600	562		
2.1	2R1			24	240			300	301		201	10000	103		
2.2	2R2			27	270			330	331		or				50V
2.4	2R4			30	300			360	361		600V Code				Code
2.7	2R7			33	330			390	391		601				500
3.0	3R0			36	360			430	431						
3.3	3R3			39	390			470	471						

♦ Part Numbering



Note: Tolerance of $\pm 0.02 pF$ is a possibility. Please contact Dalicap

♦ DLC70B Capacitor Dimensions

unit:inch(millimeter)

			Ca	pacitor D	imension	ıs		Plated		
Series	Term.	Type / Outlines	Length	Width	Thick.	Overlap	Length	Width	Thickness	Material
	Code		(Lc)	(Wc)	(Tc)	(B)	(L _L)	(W _L)	(T _L)	Wiateriai
	W	T. I	.110+.020 to010	.110 ±	.10	.024				100% Sn over Nickel Plating
70B	L	Chip	(2.79+0.51 to -0.25)	.010 (2.79 ±0.25)	(2.54) max	(0.60) max	_	_	_	90 Sn10Pb over Nickel Plating
			.135	.110				.093	.008± .001	Silver-
70B	MS	тІ	± ±		.10		.250	± .005 (2.36	(0.2 ± 0.025)	plated Copper
	IVIS		.015	.010 (2.79 ±0.25)	(2.54)	_	(6.35)		.004± .001	100%
		Microstrip	±0.38)		max		min	±0.13)	(0.1 ± 0.025)	Silver

			Caj	pacitor D	imension	ıs]	D1 (1		
Series Term Code		Type / Outlines	Length (Lc)	Width (Wc)	Thick. (Tc)	Overlap (B)	Length (L _L)	Width (W _L)	Thickness (T _L)	Plated Material
70B	P	Chip (Non-Magnetic)	.110+.020 to010 (2.79+0.51 to-0.25)	.110 ± .010 (2.79 ±0.25)	.10 (2.54) max	.024 (0.60) max	_	_	_	100% Sn over Copper Plating RoHS Compliant
70B	MN	Microstrip (Non-Magnetic)	.135 ± .015 (3.43 ±0.38)	.110 ± .010 (2.79 ±0.25)	.10 (2.54) max	_	.250 (6.35) min	.093 ± .005 (2.36 ±0.13)	.008± .001 (0.2± 0.025) .004± .001 (0.1± 0.025)	Silver- plated Copper

Note: non-mag is no magnetism.

♦ Performance

Item	Specifications			
Quality Factor (Q)	greater than 10,000 at 1 MHz			
	0.1 pF to 470 pF:			
	10 ⁶ Megohms min. @ +25 °C at rated WVDC.			
Ingulation Projectance (ID)	10 ^s Megohms min. @ +125 °C at rated WVDC.			
Insulation Resistance (IR)	510 pF to 10000 pF:			
	10 ⁵ Megohms min. @ +25 °C at rated WVDC.			
	10⁴ Megohms min. @ +125℃ at rated WVDC.			
Rated Voltage	See Rated Voltage Table			
	250% of Rated Voltage for 5 seconds, Rated Voltage ≤ 500VDC			
Dielectric Withstanding Voltage (DWV)	150% of Rated Voltage for 5 seconds, 500VDC < Rated Voltage ≤ 1250VDC			
	120% of Rated Voltage for 5 seconds, Rated Voltage > 1250VDC			
Operating Temperature Range	-55°C to +200°C.			
Temperature Coefficient (TC)	$0\pm30 \text{ ppm/}^{\circ}\text{C} (-55^{\circ}\text{C to} +125^{\circ}\text{C});$			
Capacitance Drift	$\pm 0.02\%$ or ± 0.02 pF, whichever is greater.			
Piezoelectric Effects	None			
Termination Type	See Termination Type Table			

Capacitors are designed and manufactured to meet the requirements of MIL-PRF-55681 and MIL-PRF-123.

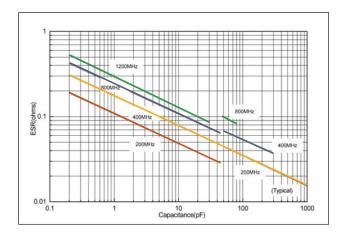
◆Environmental Tests

Item	Specifications	Method
Thermal Shock Moisture	DWV: the initial value IR: Shall not be less than 30% of the initial value Capacitance change: no more than 0.5% or 0.5pF.	MIL-STD-202, Method 107, Condition A. At the maximum rated temperature (-55°C and 200°C) stay 30 minutes. The time of removing shall not be more than 3 minutes. Perform the five cycles.
Resistance Humidity (steady state)	whichever is greater. DWV: the initial value IR: the initial value Capacitance change: no more than 0.3% or 0.3pF. whichever is greater.	MIL-STD-202, Method 106. MIL-STD-202, Method 103, Condition A, with 1.5 Volts D.C. applied while subjected to an environment of 85 °C with 85% relative humidity for 240 hours minimum.
Life	IR: Shall not be less than 30% of the initial value Capacitance change: no more than 2.0% or 0.5pF whichever is greater.	MIL-STD-202, Method 108, for 2000 hours, at 200°C. 200% of Rated Voltage for Capacitors, Rated Voltage ≤ 500VDC 120% of Rated Voltage for Capacitors, 500VDC < Rated Voltage ≤ 1250VDC 100% of Rated Voltage for Capacitors, Rated Voltage > 1250VDC

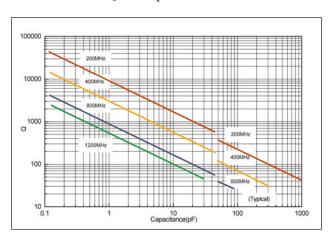


◆DLC70B Performance Curve

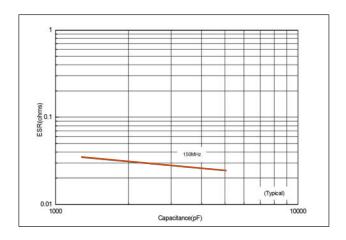
ESR vs Capacitance



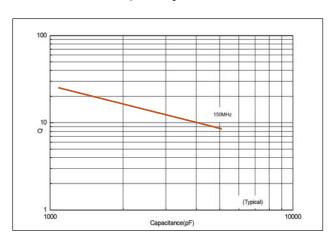
Q vs Capacitance



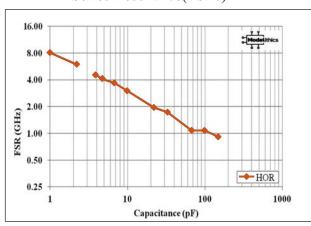
ESR vs Capacitance



Q vs Capacitance



DLC70B Horizontal First Series Resonance(FSRs)



Definitions and Measurement Conditions

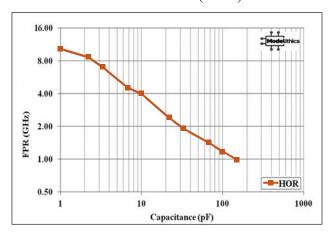
For a capacitor in a series configuration, i.e., mounted across a gap in a microstrip trace, with 50-Ohm source and termination resistances, the First Series Resonance, FSR, is defined as the lowest frequency at which the imaginary part of the input impedance, Im[Zin], equals zero. Should Im[Zin] or the real part of the input impedance, Re[Zin], not be monotonic with frequency at frequencies lower than those at which Im[Zin] = 0, the FSR shall be considered as undefined (gap in plot above). FSR is dependent on internal capacitor structure; substrate thickness and dielectric constant; capacitor orientation, as defined above; and mounting

The measurement conditions are: substrate -- Rogers RO4350; substrate dielectric constant =3.66; horizontal mount substrate thickness (mils) = 50; gap in microstrip trace (mils) = 72; horizontal mount microstrip trace width (mils) = 110. Reference planes at sample edges.

All data has been derived from electrical models created by Modelithics, Inc., a specialty vendor contracted by DLC. The models are derived from measurements on a large number of parts disposed on several different substrates.

◆DLC70B Performance Curve

DLC70B Horizontal First Parallel Resonance(FPRs)



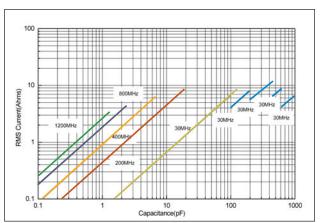
Definitions and Measurement conditions:

For a capacitor in a series configuration, i.e., mounted across a gap in a microstrip trace, with 50-Ohm source and termination resistances, the First Parallel Resonance, FPR, is defined as the lowest frequency at which a suckout or notch appears in |S21|. It is generally independent of substrate thickness or dielectric constant, but does depend on capacitor orientation. A horizontal orientation means the capacitor electrode planes are parallel to the plane of the substrate; a vertical orientation means the electrode planes are perpendicular to the substrate.

The measurement conditions are: substrate -- Rogers RO4350; substrate dielectric constant = 3.66; horizontal mount substrate thickness (mils) = 50; gap in microstrip trace (mils) = 72; horizontal mount microstrip trace width (mils) = 110. Reference planes at sample edges.

All data has been derived from electrical models created by Modelithics, Inc., a specialty vendor contracted by DLC. The models are derived from measurements on a large number of parts disposed on several different substrates.

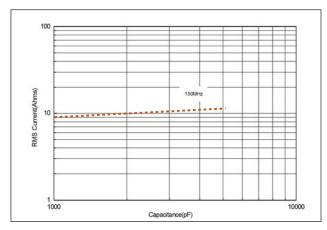
Current Rating vs Capacitance



The current depends on voltage limited: $I = \frac{\sqrt{2}}{2}I_{peak} = \frac{\sqrt{2}}{2} \times \frac{V_{rated}}{X_C} = \sqrt{2}\pi FCV_{rated}$

The current depends on power dissipation limited: $I = \sqrt{\frac{P_{dissipation}}{ESR}}$

Current Rating vs Capacitance

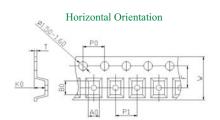


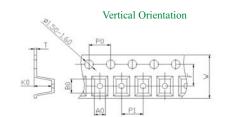
Note: If the thermal resistance of mounting surface is 20°C/W.

then a power dissipation of 3 W will result in the current limited we can calculate the current limited $I = \sqrt{\frac{P_{dissipation}}{ESR}}$

◆ Tape & Reel Specifications

Orientation	EIA	A0	В0	K0	W	P0	P1	Т	F	Qty/reel	Tape Material
Horizontal	1111	2.85	3.90	1.95	8.00	4.00	4.00	0.22	3.50	2000	Plastic
Vertical	1111	2.00	3.50	2.70	12.00	4.00	4.00	0.40	5.50	1500	Plastic
Vertical	1111	2.96	3.60	2.40	8.00	4.00	4.00	0.22	3.50	1500	Plastic





◆ Design Kits

These capacitors are 100% RoHS. Kits are available in Magnetic and Non-Magnetic that contain 10(ten) pieces per value.

Design Kit	Description (pF)	Values (pF)	No. of values	Tolerance
		1.0, 1.2, 1.5, 1.8, 2.0, 2.2, 2.4, 2.7		±0.10pF
DKDLC70B01	1.0 - 10	3.0, 3.3, 3.9, 4.7, 5.6, 6.8, 8.2	16	± 0.25pF
		10		± 5%
DKDLC70B02	10 - 100	10, 12, 15, 18, 20, 22, 24, 27, 30, 33, 39, 47, 56, 68, 82, 100	16	± 5%
DKDLC70B03	100 - 1000	100, 120, 150, 180, 200, 220, 240, 270, 300, 330, 390, 470, 560, 680, 820, 1000	16	± 5%
DKDLC70B04	1000 - 10000	1000, 1100, 1200, 1500, 1800, 2000, 2200, 2700, 3000, 3300, 3900, 4700, 5600, 10000	14	± 5%
	1.0 - 10	1.0, 1.2, 1.5, 1.8, 2.0, 2.2, 2.4, 2.7,		±0.10pF
DKDLC70B05	Non-magnetic	3.0, 3.3, 3.9, 4.7, 5.6, 6.8, 8.2	16	± 0.25pF
	Tion magnetic	10		±5%
DKDLC70B06	10 - 100 Non-magnetic	10, 12, 15, 18, 20, 22, 24, 27, 30, 33, 39, 47, 56, 68, 82, 100	16	± 5%
DKDLC70B07	100 - 1000 Non-magnetic	100, 120, 150, 180, 200, 220, 240, 270, 300, 330, 390, 470, 560, 680, 820, 1000	16	±5%
DKDLC70B08	1000 - 10000 Non-magnetic	1000, 1100, 1200, 1500, 1800, 2000, 2200, 2700, 3000, 3300, 3900, 4700, 5600, 10000	14	±5%

